PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Akira SHIMIZU	02/13/2008
Akira WATANABE	02/13/2008

RECEIVING PARTY DATA

Name:	ASM JAPAN K.K.	
Street Address:	23-1, 6-chome, Nagayama	
City:	Tama-shi, Tokyo	
State/Country:	JAPAN	
Postal Code:	206-0025	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12027767

CORRESPONDENCE DATA

Fax Number: (949)760-9502

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 949-760-0404
Email: efiling@kmob.com

Correspondent Name: Knobbe, Martens, Olson & Bear LLP

Address Line 1: 2040 Main Street, 14th Floor Address Line 4: Irvine, CALIFORNIA 92614

ATTORNEY DOCKET NUMBER: ASMJP.237AUS

NAME OF SUBMITTER: Katsuhiro Arai

Total Attachments: 1

source=ASMJP-237AUS_Assignment#page1.tif

PATENT REEL: 020510 FRAME: 0005

500464064

. 구 840,00

PATENT

Application No.: 12/027,767 Filing Date: February 7, 2008 Client Code: ASMJP,237AUS

Page 1

ASSIGNMENT

WHEREAS, We, Akira Shimizu, a Japanese citizen, residing at 23-1, 6-chome, Nagayama, Tama-shi, Tokyo 206-0025 Japan, and Akira Watanabe, a Japanese citizen, residing at 23-1, 6-chome, Nagayama, Tama-shi, Tokyo 206-0025 Japan, have invented certain new and useful improvements in a CLAMPING MECHANISM FOR SEMICONDUCTOR DEVICE for which we have executed an application for Letters Patent in the United States, on February 7, 2008 as Application Serial No. 12/027,767;

AND WHEREAS, ASM JAPAN K. K. (hereinafter "ASSIGNEE"), a Japan Corporation, with its principal place of business at 23-1, 6-chome, Nagayama, Tama-shi, Tokyo 206-0025 Japan, desires to acquire the entire right, title, and interest in and to the said improvements and the said Application:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the said inventors, do hereby acknowledge that we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and we hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

This 13 day of February, 2008	ARIN Shimizu
This 13 day of February, 2008 Witness Whyn MOVIMOTO	Akira Watanabe Akira WATANABE

4869253 021108

> PATENT REEL: 020510 FRAME: 0006